



Thank you for attending the 65th ECTC!

I would like to thank all authors, presenters, program committee members, exhibitors, sponsors, volunteers and attendees for making the 65th ECTC the most attended ECTC in our 65 year history.

Here are some conference statistics:

- 1,559 attendees, the highest attendance ever
- Attendees came from 32 different countries
- 361 technical papers, presented in 36 oral and five interactive presentation sessions, including a student poster session
- 27 sponsorships - another new record
- 16 Professional Development Courses, attended by 417 participants
- 106 Technology Corner Booths, also a new record - with most exhibitors already committed to return next year!

In addition to the regular daytime sessions and courses, we offered a record six additional special sessions, including three special sessions on Tuesday afternoon and three evening seminars that were all very well attended:

- **ECTC Special Session**
 - Co-chaired by Jie Xue of Cisco Systems and CPMT President and James Morris of Portland State University on nanopackaging.
- **ECTC Plenary Session**
 - Chaired by Jan Vardaman of TechSearch International, Inc. on the Internet of Things and the future of interconnected electronics.
- **CPMT Seminar**
 - Co-chaired by Venky Sundaram of the Georgia Institute of Technology and Yasumitsu Orii of IBM Research Tokyo on liquid and phase-change cooling for high-performance systems.
- **Assembly and Manufacturing and Advanced Packaging Special Session**
 - Co-chaired by Shawn Shi of Medtronic and John Knickerbocker of IBM Corporation on biomedical technology and associated packaging.
- **ECTC Special Session**
 - Chaired by Ibrahim Guven of Virginia Commonwealth University on sustainability in microelectronics.
- **First-ever CPMT Women's Panel**
 - I had the privilege of chairing this session with some of the most successful women in our industry today and discussed owning your professional success.

Finally, thank you to the ECTC Keynote Speaker, Matt Grob, Executive Vice President and CTO of Qualcomm Technologies, Inc., who gave a fabulous presentation on our "Smartphone-Powered Future."

I would like to thank our corporate sponsors - particularly our Gold Gala sponsors: Deca Technologies, Nanium, Amkor, DOW Electronic Materials, and SPTS; our Silver Gala Sponsors AMAT, Micron, and Suss; and our Luncheon, Program, and Special sponsors GLOBALFOUNDRIES, ASE, and TOK.

I would also like to recognize our youngest speaker ever, Mr. Yuci Shen, a 17-year old high school student, for presenting his work, "Achieving Warpage-Free Packaging: A Capped-Die Flip Chip Package Design," resulting from an internship at Lamar University.

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The audience was very impressed by the quality of the research and the clarity of the presentation.

Photos taken at the conference will soon be posted on Flickr.

ECTC 2016 will be held 31 May 31 - 3 June 2016, at The Cosmopolitan of Las Vegas, Las Vegas, NV, USA. Las Vegas is an amazing venue and I hope to see you there!

Best,



Beth Keser, Ph.D.
General Chair, 65th Electronic Components and Technology Conference
Qualcomm Technologies, Inc.

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